ES_LPC4370/50/30/20/10

Errata sheet LPC4370, LPC4350, LPC4330, LPC4320, LPC4310

Rev. 7.2 — February 7, 2023 Errata sheet

Document information

Info	Content
Keywords	LPC4370FET100; LPC4370FET256; LPC4350FET256; LPC4350FET180; LPC4330FET180; LPC4330FET100; LPC4330FBD144; LPC4320FET100; LPC4320FBD144; LPC4310FBD144; Cortex-M4 flashless; Rev A, C, D, F errata
Abstract	This errata sheet describes both the known functional problems and any deviations from the electrical specifications known at the release date of this document. Each deviation is assigned a number and its history is tracked in a table.



Revision history

Rev	Date	Description
7.2	20230207	Added Rev F.
		Updated for device revision with copper wire conversion.
7.1	20180307	• USBROM.4
7	20160511	Added RTC.1.
6.9	20160408	Fixed master page to make the heading title appear on page 2.
6.8	20160401	Added Rev. D.
		Updated OTP.2 work-around for BGA256 and other packages.
6.7	20151023	Added RESET.3.
6.6	20150911	Removed reference to LQFP208 package from Section 3.4 "EMC.2".
6.5	20150904	 Added the word linear to the ramp-up time for the first work-around in OTP.2. For all packages, except BGA256, if the VDDREG, VDDIO, and VDDA pins are tied together, the supply voltage must have a linear ramp-up time of at least 2 ms. See Section 3.12.
6.4	20150827	Added OTP.2.
6.3	20150417	Added SD/MMC.1.
		Added EMC.2.
		Removed non-orderable parts LPC4350FBD208 and LPC4320FBD100. Add DECET4
		Added RESET.1. Added RESET.2.
6.2	20140814	IAP.1 updated. See Section 3.6.
0.2	20140014	IRC.1 removed. IRC specification changed in data sheet.
6.1	20131122	Corrected retained memory location for SRAM.1 to 0x10088000.
6	20131021	Added USBROM.2, USBROM.3, SRAM.1.
		Added LPC4370FET100 and LPC4370FET256.
5	20130715	Added EMC.1, IRC.1, IDDA, USB.1, ISP.2.
		Renamed CDC.1 to USBROM.1.
		Document name changed from ES_LPC43X0_A to ES_LPC43X0.
4	20130125	Added I2C.1.
3	20121203	Updated C_CAN.1.
		Added Rev. C.
		Removed AES.1, ETM.1, RGU.1, SPIFI.2; documented in user manual.
		Added CDC.1.Updated work-around for IBAT.1.
2.2	20120808	Added IBAT.2 and RGU.1.
۷.۷	20120000	Corrected C_CAN0/C_CAN1 peripheral assignment.
2.1	20120713	Added C_CAN.1.
	20.207.10	

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Revision history ...continued

Rev	Date	Description
1.4	20120601	Added ISP.1, ETM.1, IAP.1, PMC.1 and IBAT.1.
1.3	20120401	Updated SPIFI.1.
		Added SPIFI.2.
		Removed ADC.1 and USB0.1.
1.2	20120201	Added OTP.1.
1.1	20120123	Added ADC.1.
1	20120103	Initial version.

1. Product identification

The LPC4370/50/30/20/10 devices (hereafter referred to as 'LPC43x0') typically have the following top-side marking:

LPC43x0xxxxxx

XXXXXXX

xxxYYWWxR[x]

The last/second to last letter in the last line (field 'R') will identify the device revision. This Errata Sheet covers the following revisions of the LPC43x0:

Table 1. Device revision table

Revision identifier (R)	Revision description
'A'	Initial device revision
'C'	Second device revision
'D'	Third device revision
'F'	Fourth device revision

Field 'YY' states the year the device was manufactured. Field 'WW' states the week the device was manufactured during that year.

2. Errata overview

Table 2. Functional problems table

Functional problems	Short description	Revision identifier	Detailed description
BOOT.1	USB1 boot is not functional.	'A'	Section 3.1
C_CAN.1	Writes to CAN registers write through to other peripherals.	'A', 'C', 'D', 'F'	Section 3.2
EMC.1	External Memory Controller clock frequency divide by 2 mode limit.	'A', 'C', 'D', 'F'	Section 3.3
EMC.2	Operating frequency of EMC lower than data sheet value.	'A', 'C', 'D', 'F'	Section 3.4
I2C.1	In the slave-transmitter mode, the device set in the monitor mode must write a dummy value of 0xFF into the DAT register.	'A', 'C', 'D', 'F'	Section 3.5
IAP.1	In-Application Programming API not present on flashless parts.	'A', 'C', 'D', 'F'	Section 3.6
IDDA.1	Increased IDDA current in low power modes.	'C', 'D', 'F'	Section 3.7
ISP.1	Part ID format incorrect.	'A', 'C', 'D', 'F'	Section 3.8
ISP.2	'J' command in ISP mode swaps last two items.	'C' (with a boot ROM version of 11.2), 'D', 'F'	Section 3.9
MCPWM.1	MCPWM abort pin not functional.	'A', 'C', 'D', 'F'	Section 3.10
OTP.1	OTP ROM driver may not program boot source.	'A', 'C', 'D', 'F'	Section 3.11
OTP.2	Repeated power cycling of the device may cause erroneous programming of the OTP banks.	'A', 'C'	Section 3.12

Table 2. Functional problems table ...continued

Functional problems	Short description	Revision identifier	Detailed description
PMC.1	PMC.x power management controller fails to wake up from deep sleep, power down, or deep power down.	'A', 'C', 'D', 'F'	Section 3.13
SPIFI.1	Rebooting from some SPIFI devices will be delayed by 60 seconds.	'A'	Section 3.14
SRAM.1	Misconfigured parts.	'A', 'C' (with a date code ≤ 1315)	Section 3.15
USB.1	USB0 unable to communicate with low-speed USB peripheral in host mode when using full-speed hub.	'A', 'C', 'D', 'F'	Section 3.16
USBROM.1	The CDC class USB ROM drivers return a STALL condition.	'A'	Section 3.17
USBROM.2	Nested NAK handling of EP0 OUT endpoint.	'A', 'C', 'D', 'F'	Section 3.18
USBROM.3	Isochronous transfers.	'A', 'C', 'D', 'F'	Section 3.19
USBROM.4	USB full-speed device fail in the Command/Data/Status Flow after bus reset and bus re-enumeration.	'A', 'C', 'D', 'F'	Section 3.20
SD/MMC.1	Data CRC error returned on CMD6 command.	'A', 'C', 'D', 'F'	Section 3.21
RESET.1	Master Reset (MASTER_RST) and M4 Reset (M4_RST) are not functional.	'A', 'C', 'D', 'F'	Section 3.22
RESET.2	PERIPH_RST is not functional.	'A', 'C', 'D', 'F'	Section 3.23
RESET.3	Loss of device functionality on reset via nRESET in deep-sleep and power-down mode.	'A', 'C', 'D', 'F'	Section 3.24
RTC.1	The Real Time Clock (RTC) does not work reliably when there is I/O switching activity on pins near to the RTCX1 oscillator input pin.	'A', 'C', 'D', 'F'	Section 3.25

Table 3. AC/DC deviations table

AC/DC deviations	Short description	Revision identifier	Detailed description
IBAT.1	VBAT supply current higher than expected.	'A', 'C', 'D', 'F'	Section 4.1
IBAT.2	VBAT supply current higher than expected.	'A'	Section 4.2
PWR.1	Deep sleep and power-down mode consume more current than expected.	'A'	Section 4.2

Table 4. Errata notes table

Errata notes	Short description	Revision identifier	Detailed description
n/a	n/a	n/a	n/a

3. Functional problems detail

3.1 BOOT.1

Introduction:

The internal ROM memory is used to store the boot code of the LPC43x0. After a reset, the ARM processor will start its code execution from this memory. The boot ROM memory includes the following features:

• ...Boot from USB1....

Problem:

Boot from USB1 is not functional. This does not affect use of USB1 after boot-up.

Work-around:

USB0 can be used to boot the part.

3.2 C_CAN.1

Introduction:

Controller Area Network (CAN) is the definition of a high performance communication protocol for serial data communication. The C_CAN controller is designed to provide a full implementation of the CAN protocol according to the CAN Specification Version 2.0B. The C_CAN controller allows to build powerful local networks with low-cost multiplex wiring by supporting distributed real-time control with a very high level of security.

Problem:

On the LPC43x0, there is an issue with the C_CAN controller AHB bus address decoding that applies to both C_CAN controllers. It affects the C_CAN controllers when peripherals on the same bus are used. Writes to the ADC, DAC, I2C, and I2S peripherals can update registers in the C_CAN controller. Specifically, writes to I2C0, MCPWM, and I2S can affect C_CAN1. Writes to I2C1, DAC, ADC0, and ADC1 can affect C_CAN0. The spurious C_CAN controller writes will occur at the address offset written to the other peripherals on the same bus. For example, a write to ADC0 CR register which is at offset 0 in the ADC, will result in the same value being written to the C_CAN0 CNTL register which is at offset 0 in the C_CAN controller. Writes to the C_CAN controller will not affect other peripherals.

Work-around:

Work-arounds include: Using a different C_CAN peripheral. Peripherals I2C1, DAC, ADC0, and ADC1 can be used at the same time as C_CAN1 is active without any interference. The I2C0, MCPWM, and I2S peripherals can be used at the same time as C_CAN0 is active without any interference. Another work-around is to gate the register clock to the CAN peripheral in the CCU. This will prevent any writes to other peripherals from taking effect in the CAN peripheral. However, gating the CAN clock will prevent the CAN peripheral from operating and transmitting or receiving messages. This work-around is most useful if your application is modal and can switch between different modes such as an I2S mode and a CAN mode. Another work-around is to avoid writes to the peripherals while CAN is active. For example, the ADC could be configured to sample continuously or when triggered by a timer, before the CAN is configured. Afterwards, C_CAN0 can be used since the ADC will operate without requiring additional writes.

3.3 EMC.1

Introduction:

The LPC43x0 parts contain an External Memory Controller (EMC) capable of interfacing to external SDRAM, SRAM, and asynchronous parallel flash memories. The EMC can be configured to operate at the processor core frequency (BASE_M4_CLOCK) or the core frequency divided by 2.

Problem:

When operated in the divide by 2 mode (EMC_CLK_SEL, bit 16 CREG6, Address 0x4004.312C), the duty cycle of the clock is not the typical 50 % which shortens the setup time. This could impact designs with an EMC running faster than 100 MHz in divide by 2 mode (which corresponds to a maximum core frequency of 200 MHz).

Work-around:

If the external bus is running greater than 100 MHz in divide by 2 clock mode, consider the following:

- 1. When using only one external chip, use the CLK1 or CLK3 pin to drive the SDRAM clock for best performance. CLK0 and CLK2 pins are used for SDRAM read capture feedback clocks and must not be used for any other function.
- When using two x16 SDRAMs, use the CLK1 pin to drive the clock on SDRAM D15:D0, and CLK3 pin to drive the SDRAM D31:D16. CLK0 and CLK2 pins are used for SDRAM read capture feedback clocks and must not be used for any other function.

3.4 EMC.2

Introduction:

The LPC43x0 parts contain an External Memory Controller (EMC) capable of interfacing to external SDRAM, SRAM, and asynchronous parallel flash memories. The EMC can be configured to operate at the processor core frequency (BASE_M4_CLOCK) or the core frequency divided by 2.

Problem:

For SDRAM, the electrical characteristic of the LQFP144 package limits the operating frequency of the EMC to a certain level, which is lower than the specified value in the data sheet. Choosing an SDRAM clock of 72MHz as the upper limit provides some safety margin. This frequency is either achieved by a core and EMC frequency of 72MHz, or by a 144MHz core and a 72MHz EMC frequency. However, SDRAM performance can vary depending on board design and layout.

Work-around:

There is no work-around.

The upper limit of the SDRAM clock frequency is highly dependent on the PCB layout and the quality of the power supply and de-coupling circuitry.

3.5 I2C.1

Introduction:

The I2C monitor allows the device to monitor the I2C traffic on the I2C bus in a non-intrusive way.

Problem:

In the slave-transmitter mode, the device set in the monitor mode must write a dummy value of 0xFF into the DAT register. If this is not done, the received data from the slave device will be corrupted. To allow the monitor mode to have sufficient time to process the data on the I2C bus, the device may need to have the ability to stretch the I2C clock. Under this condition, the I2C monitor mode is not 100% non-intrusive.

Work-around:

When setting the device in monitor mode, enable the ENA_SCL bit in the MMCTRL register to allow clock stretching.

Software code example to enable the ENA SCL bit:

```
LPC_I2C_MMCTRL |= (1<<1); //Enable ENA_SCL bit</pre>
```

In the I2C ISR routine, for the status code related to the slave-transmitter mode, write the value of 0xFF into the DAT register to prevent data corruption. In order to avoid stretching the SCL clock, the data byte can be saved in a buffer and processed in the Main loop. This ensures the SI flag is cleared as fast as possible.

Software code example for the slave-transmitter mode:

3.6 IAP.1

Introduction:

The LPC43xx microcontrollers contain an API for In-Application Programming. This API also allows identification of the part.

Problem:

On the LPC43x0 microcontrollers, the IAP API is not present.

Work-around:

Use the ISP interface to identify the part ID externally (via the UART) or read the first word of the part ID directly from OTP memory at location 0x4004 5000. On flashless parts, the second word of the part ID is always 0.

3.7 IDDA.1

Introduction:

This part includes two 10-bit analog to digital converters that require a 3.3 V supply.

Problem:

While in deep sleep and power-down modes, analog domains show increased current. The table below shows the actual power drawn in these modes.

Work-around:

None.

Table 5. Static characteristics

 T_{amb} = -40 °C to +85 °C, unless otherwise specified

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{DDA}	analog supply current	deep sleep mode	<u>[1]</u>	-	4.2	-	μΑ
		power-down mode	<u>[1]</u>	-	4.2	-	μΑ
		deep power-down mode	<u>[1]</u>	-	0.007	-	μΑ

[1] $V_{DDA(3V3)} = 3.3 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$

3.8 ISP.1

Introduction:

A reduced set of In-System-Programming (ISP) commands are supported for flashless parts. The ISP 'J' command can be used to query the part identification number.

Problem:

On the LPC43x0 microcontrollers, the J command returns incorrectly formatted data. Instead of returning two words (plus the return code) as specified in the User's Manual, IAP command 54 and ISP command 'J' only return a single word (plus return code). That single word contains the first word of the part identification number with the first 16 bits swapped with the last 16 bits. For example, an LPC4350FET256 will return 0x0830A000 instead of the correct value, 0xA0000830.

Work-around:

When using ISP, if only one word of data is returned, swap the two 16-bit segments of the word and assume the second word of data is 0.

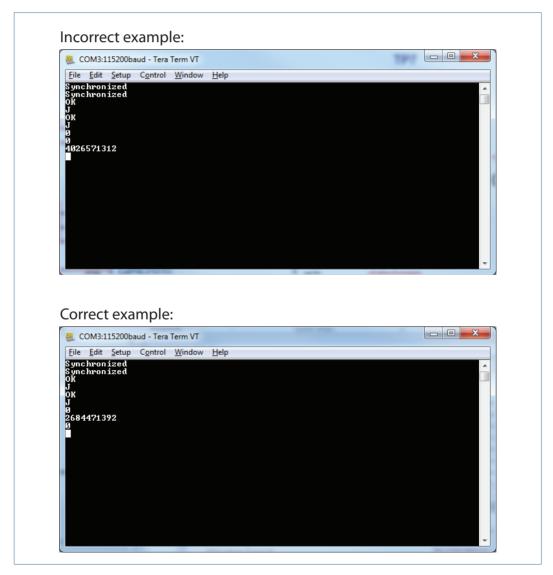
3.9 ISP.2

Introduction:

All LPC43x0 parts include a feature called In-System Programming (ISP) which boots up over the UART port and provides a terminal-based communication mechanism to query certain characteristics of the part. One of these is the ability to retrieve the Part Identification number.

Problem:

The 'J' command in ISP mode should return an error code, followed by an ASCII string representation of the part ID, followed by a 0. However what is actually returned is the error code, followed by a 0, followed by an ASCII string representation of the part ID. The problem is the last two items returned are swapped.



Work-around:

There is no work-around for this problem.

3.10 MCPWM.1

Introduction:

The Motor Control PWM engine is optimized for three-phase AC and DC motor control applications, but can be used in many other applications that need timing, counting, capture, and comparison. The MCPWM contains a global Abort input that can force all of the channels into a passive state and cause an interrupt.

Problem:

The MCPWM Abort input is not functional.

Work-around:

The MCPWM Abort function can be emulated in software with the use of a non-maskable interrupt combined with an interrupt handler that shuts down the PWM. This will result in a small delay on the order of 50 main clock cycles or about 1/3 of a microsecond at 150 MHz. Alternatively, the State Configurable Timer (SCT) can be configured to implement MCPWM functionality including an Abort input. The SCT can respond to external inputs in one clock cycle.

3.11 OTP.1

Introduction:

The LPC43x0 contain OTP memory which can configure the boot source, as well as a set of routines in ROM to program the boot source into OTP memory.

Problem:

There is a problem in the OTP boot source programming code in ROM which requires registers to be initialized in order to ensure successful boot source OTP programming.

Work-around:

1. Add this function to your program.

```
void OTP_fix(volatile unsigned dummy0, volatile unsigned dummy1, volatile unsigned
dummy2, volatile unsigned dummy3)
{
}
```

2. Call this function before calling otp_ProgBootSrc.

```
rval = otp_Init();
OTP_fix(0,0,0,0);
rval = otp ProgBootSrc(OTP BOOTSRC SPIFI);
```

This will be fixed in the next boot ROM revision.

3.12 OTP.2

Introduction:

The LPC43x0 parts contain OTP memory with four banks of 128 bits each. The first bank (OTP bank 0) is reserved. The other three OTP banks are programmable. The OTP banks can be programmed (0 \rightarrow 1) via APIs provided in the ROM.

Problem:

On all packages, repeated power cycling of the device may cause erroneous programming of the OTP banks. During ramp-up, the VDDREG supply voltage does not have enough time to settle and initialize the OTP controller before valid programming voltage is reached on the VPP pin. This may cause accidental programming of the OTP banks. Accidental programming of the OTP banks does not occur during Power-down of the supply voltage.

Work-around:

This problem is fixed in LPC43x0 Rev. D devices.

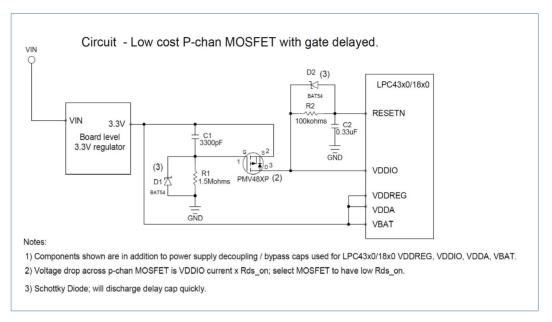
BGA256 package:

- When OTP programming is not required, the VPP pin should be left as No-Connect (NC) because the VPP and VDDIO pins are separate.
- When OTP programming is required, do not tie VPP pin to VDDREG, VDDIO and VDDA pins. The voltage on the VPP pin should be delayed by 2 ms after the power supply on the VDDREG, VDDA, and VDDIO pins reaches the operating voltage level.

Other packages:

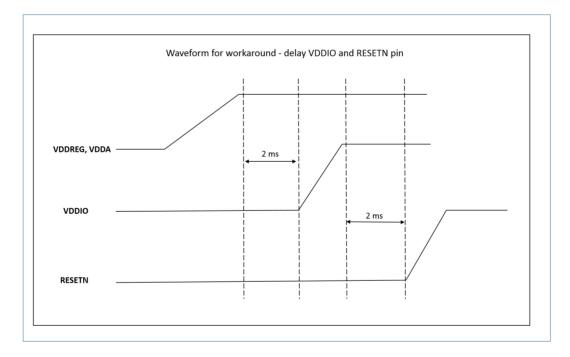
 Do not tie VDDIO to VDDREG and VDDA pins. The power supplied to the VDDIO pin should be delayed by 2 ms after the power supply on the VDDREG and VDDA pins stabilizes at the operating voltage level. The signal to the RESETN pin must also be delayed by 2 ms after the power supply on the VDDIO pin stabilizes at the operating voltage level.

The following circuit diagram is an example that shows the P-channel MOSFET with the gate delayed and the R-C delay circuit connected to the RESETN pin.



For this problem, there is no restriction on the VBAT supply.

The following diagram shows the waveform for the work-around.



3.13 PMC.1

Introduction:

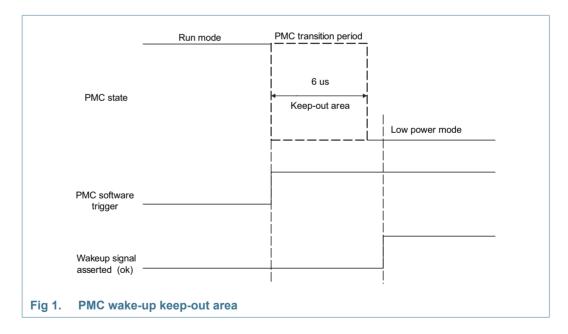
The PMC implements the control sequences to enable transitions between different power modes and controls the power state of each peripheral. In addition, wake-up from any of the power-down modes based on hardware events is supported.

Problem:

When the chip is in a transition from active to deep Sleep, power down, or deep power down, wake-up events are not captured and they will block further wake-up events from propagating. The time window for this transition is 6 uS and is not affected by the chip clock speed. After a wake-up event is received during the PMC transition, the chip can only recover by using an external hardware reset or by cycling power.

Work-around:

Make sure that a wake-up signal is not received during the deep sleep, power down, or deep power down transition period. An example circuit to work around this could include an external 6 μS one shot which could be triggered via software using a GPIO line when entering deep sleep, power down, or deep power down mode. The one-shot's output could be used to gate the wake-up signal(s) to prevent receiving a wake-up signal during the PMC transition period. Depending on the system design, it may also be needed to latch the wake-up signal(s) so that they will still be present after the one-shot's 6 μS time-out.



3.14 SPIFI.1

Introduction:

The boot ROM includes a SPI Flash Interface (SPIFI) driver that allows low-cost serial flash memories to be connected to the ARM Cortex-M4 processor with little performance penalty compared to parallel flash devices with higher pin count. SPIFI provides a memory-mapped area where the contents of the external serial flash memory appear.

Problem:

The boot ROM does not properly re-initialize the external serial flash device if it is already set up for "no opcode" or "continuous read" mode. This affects use after unplanned resets such as a hardware reset or watchdog timer reset. Booting from SPIFI is affected and may not be successful until after the 60 second boot failure time-out if the external serial flash device is in "no opcode" or "continuous read" mode.

Work-around:

During a planned reboot, remove the external QSPI flash from no opcode mode before resetting the CPU by using the SPIFI driver library's cancel_mem_mode call. The SPIFI driver library is available from lpcware.com. In the event of an unplanned reset, the driver will initialize the flash device if it is called a second time so an external watchdog could be provided to reset the CPU in case of boot failure from SPIFI. Finally there is a built-in 60-second boot time-out which will result in a successful boot after one minute in the event of a failure.

3.15 SRAM.1

Introduction:

The LPC4320/10 parts all have an 8 kB region of internal SRAM that is retained during Sleep, deep-sleep, and power-down modes. This retained memory is located at 0x10088000.

Problem:

Parts with date codes marked \leq 1315 locate the 8 kB of retained memory at 0x10090000. Also, the part numbers for these parts returned by the ISP Read Part Identification command is incorrect.

The correct part numbers look like this:

Device	Hex coding	
	Word0	Word1
LPC1850FET256	0xF000 D830	0x0000 0000
LPC1850FET180	0xF000 D830	0x0000 0000
LPC1830FET256	0xF000 DA30	0x0000 0000
LPC1830FET180	0xF000 DA30	0x0000 0000
LPC1830FET100	0xF000DA30	0x0000 0000
LPC1830FBD144	0xF000 DA30	0x0000 0000
LPC1820FET100	0xF00A DB3C	0x0000 0000
LPC1820FBD144	0xF00A DB3C	0x0000 0000
LPC1820FBD100	0xF00A DB3C	0x0000 0000
LPC1810FET100	0xF00B 5B3F	0x0000 0000
LPC1810FBD144	0xF00B 5B3F	0x0000 0000
LPC4320FET100	0xA000 CB3C	0x0000 0000
LPC4320FBD144	0xA000 CB3C	0x0000 0000
LPC4310FET100	0xA00A CB3F	0x0000 0000
LPC4310FBD144	0xA00A CB3F	0x0000 0000

Fig 2. Correct part numbers

The misconfigured parts discussed in this errata have part numbers that look like this:

Device	Hex coding	
	Word0	Word1
LPC1850FET256	0xF000 9830	0x0000 0000
LPC1850FET180	0xF000 9830	0x0000 0000
LPC1830FET256	0xF000 9A30	0x0000 0000
LPC1830FET180	0xF000 9A30	0x0000 0000
LPC1830FET100	0xF000 9A30	0x0000 0000
LPC1830FBD144	0xF000 9A30	0x0000 0000
LPC1820FET100	0xF00A 9B3C	0x0000 0000
LPC1820FBD144	0xF00A 9B3C	0x0000 0000
LPC1820FBD100	0xF00A 9B3C	0x0000 0000
LPC1810FET100	0xF00B 1B3F	0x0000 0000
LPC1810FBD144	0xF00B 1B3F	0x0000 0000
LPC4320FET100	0xA000 8B3C	0x0000 0000
LPC4320FBD144	0xA000 8B3C	0x0000 0000
LPC4320FBD100	0xA000 8B3C	0x0000 0000
LPC4310FET100	0xA00A 8B3F	0x0000 0000
LPC4310FBD144	0xA00A 8B3F	0x0000 0000

Fig 3. Misconfigured part numbers

Work-around:

There is no way to change the memory configuration of these parts. However it is advised that software check the value of the part number returned from the ISP Read Part Identification command and take the appropriate action based on what value is read. If bit 14 equals 0 then the part is misconfigured as described in this errata.

3.16 USB.1

Introduction:

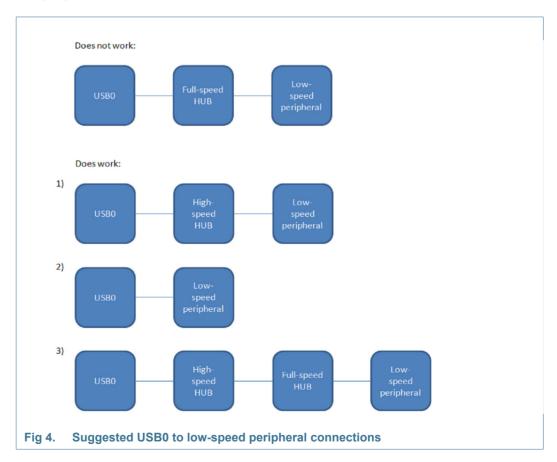
The LPC43x0 parts include two USB 2.0 controllers that can operate in host mode at high-speed. One of these controllers, USB0, contains an on-chip high-speed UTMI+ compliant transceiver (PHY) which supports high-speed, full-speed, and low-speed USB-compliant peripherals.

Problem:

The USB controller called USB0 is unable to communicate with a low-speed USB peripheral in host mode when there is a full-speed hub directly connected to the USB0 port and a low-speed peripheral is connected in the tree somewhere below this full-speed hub. Only USB0 has this problem; the other USB controller, USB1 does not.

Work-around:

There is no work-around for this problem. It is suggested that the low-speed USB peripheral is either connected directly to USB0 or a high-speed hub is placed between that peripheral and USB0.



3.17 USBROM.1

Introduction:

The CDC class USB ROM drivers have a bug that causes some Windows terminal emulation programs like Hyperterm to fail to connect. This bug only exists in revision 'A' parts.

Problem:

The CDC class USB ROM drivers return a STALL condition after the DATA stage of a Set Line Coding CONTROL transfer from the host. The correct behavior is to return an ACK.



Work-around:

The way to work around this bug is to override the default CDC class specific endpoint 0 handler and handle the processing of OUT packets in your application. Use the following source code in red to accomplish this.

```
USB EP HANDLER T g defaultCdcHdlr; // default CDC handler
ErrorCode t CDC ep0 override hdlr(USBD HANDLE T hUsb, void* data, uint32 t event)
  USB CORE CTRL T* pCtrl = (USB CORE CTRL T*)hUsb;
  USB CDC CTRL T* pCdcCtrl = (USB CDC CTRL T*) data;
  ErrorCode t ret = ERR USBD UNHANDLED;
  if ( (event == USB EVT OUT) &&
      (pCtrl->SetupPacket.bmRequestType.BM.Type == REQUEST CLASS) &&
      (pCtrl->SetupPacket.bmRequestType.BM.Recipient == REQUEST TO INTERFACE) &&
      ((pCtrl->SetupPacket.wIndex.WB.L == pCdcCtrl->cif num) || /* IF number correct?
      (pCtrl->SetupPacket.wIndex.WB.L == pCdcCtrl->dif num)) ) {
    pCtrl->EPOData.pData -= pCtrl->SetupPacket.wLength;
    ret = pCdcCtrl->CIC SetRequest(pCdcCtrl, &pCtrl->SetupPacket,
     &pCtrl->EPOData.pData,
       pCtrl->SetupPacket.wLength);
    if ( ret == LPC OK) {
      USBD API->core->StatusInStage(pCtrl);
                                                                /* send Acknowledge */
```

3.18 USBROM.2

Introduction:

The USB ROM drivers include a default endpoint 0 handler which acts on events generated by the USB controller as a result of traffic occurring over the control endpoint. The user has the option of overloading this default handler for the purpose of performing user specific processing of control endpoint traffic as required.

One of the actions the default endpoint 0 handler performs is to prepare the DMA engine for data transfer after the controller has sent out a NAK packet to the host controller. This is done in preparation for the arrival of the next OUT request received from the host.

Problem:

Due to a race condition there is the chance that a second NAK event will occur before the default endpoint0 handler has completed its preparation of the DMA engine for the first NAK event. This can cause certain fields in the DMA descriptors to be in an invalid state when the USB controller reads them, thereby causing a hang.

Work-around:

Override the default endpoint 0 handler to add checks for and prevents nested NAK event processing activity.

This is an example of how to do this:

```
// Endpoint 0 patch that prevents nested NAK event processing
static uint32 t q epORxBusy = 0; /* flaq indicating whether EPO OUT/RX buffer is
static USB EP HANDLER T g Ep0BaseHdlr; /* variable to store the pointer to base EP0
handler */
/*-----
 EPO patch:
 *-----*/
ErrorCode t EPO patch (USBD HANDLE T hUsb, void* data, uint32 t event)
   switch (event) {
      case USB EVT OUT NAK:
          if (q epORxBusy) {
             /* we already queued the buffer so ignore this NAK event. */
             return LPC OK;
             /* Mark EPO RX buffer as busy and allow base handler to queue the
    buffer. */
             g ep0RxBusy = 1;
          break;
      case USB EVT SETUP: /* reset the flag when new setup sequence starts */
      case USB EVT OUT:
          /* we received the packet so clear the flag. */
          g ep0RxBusy = 0;
```

```
break;
   return g Ep0BaseHdlr(hUsb, data, event);
// Install the endpoint 0 patch immediately after USB initialization via the
    hw->Init() call.
*_____
 usbd init: usb subsystem init routine
*-----*/
ErrorCode t usbd init (void)
   USBD API INIT PARAM T usb param;
   USB CORE DESCS T desc;
   ErrorCode t ret = LPC OK;
   USB CORE CTRL T* pCtrl;
   /* USB Initialization */
   ret = USBD API->hw->Init(&g AdcCtrl.hUsb, &desc, &usb param);
   if (ret == LPC OK) {
      /* register EPO patch */
      pCtrl= (USB CORE CTRL T^*)g AdcCtrl.hUsb; /^* convert the handle to control
    structure */
      g Ep0BaseHdlr = pCtrl->ep event hdlr[0]; /* retrieve the default EP0 OUT
    handler */
      pCtrl->ep event hdlr[0] = EPO patch; /* set our patch routine as EPO OUT
    handler */
return LPC OK;
```

3.19 USBROM.3

Introduction:

The USB ROM drivers configure and manage data structures used by the USB controller's DMA engine to move data between the controller's internal fifos and system memory. The configuration of these data structures are based on many parameters including the type of transfer, control, bulk, interrupt, or isochronous, that is to be performed. These data structures reside in system RAM on a 2 kB boundary and are pointed to by the ENDPOINTLISTADDR register.

Problem:

The USB ROM drivers incorrectly configures the Endpoint Capabilities/Characteristics field of the device Queue Head (dQH) structure for isochronous endpoints. Specifically, the MULT member is set to 0 and the ZLT member is set to 1. Also if the maximum size of isochronous packets are 1024 bytes the Max_packet_length member will be set to 0. For any other packet size this member is set correctly.

Work-around:

To use isochronous transfers with the USB ROM drivers the Endpoint Capabilities/Characteristics field must be correctly configured for that endpoint's device Queue Head structure. The USB ROM driver always sets this field (incorrectly) when the host sends a Set Interface control packet and then it calls the USB_Interface_Event callback routine, so the field must be set with the proper value in this callback routine.

This is the device Queue Head structure:

```
typedef volatile struct
{
  volatile uint32_t cap;
  volatile uint32_t curr_dTD;
  volatile uint32_t next_dTD;
  volatile uint32_t total_bytes;
  volatile uint32_t buffer0;
  volatile uint32_t buffer1;
  volatile uint32_t buffer2;
  volatile uint32_t buffer3;
  volatile uint32_t buffer4;
  volatile uint32_t setup[2];
  volatile uint32_t setup[2];
  volatile uint32_t gap[4];
} DQH_T;
```

This is an Interface Event callback routine:

```
ErrorCode_t USB_Interface_Event (USBD_HANDLE_T hUsb)
{
    USB_CORE_CTRL_T* pCtrl = (USB_CORE_CTRL_T*)hUsb;
    uint16_t wIndex = pCtrl->SetupPacket.wIndex.W; // Interface number
    uint16_t wValue = pCtrl->SetupPacket.wValue.W; // Alternate setting number

if (wIndex == isochronous_interface_number && wValue == 1)
    {
```

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```
DQH_T* ep_QH = *(DQH_T**)0x40006158; // ENDPOINTLISTADDR register
int QH_idx = ((endpoint_address & 0x0F) << 1) + 1;

ep_QH[QH_idx].cap = ((packets_executed_per_transaction_descriptor << 30) |
   (maximum_packet_size << 16));
}
return LPC_OK;
}</pre>
```

The value of isochronous_interface_number should correspond to the interface number in the USB descriptor that holds the isochronous endpoint you wish to use.

The value of maximum_packet_size should correspond to the wMaxPacketSize member of the isochronous endpoint descriptor

The value of endpoint_address should correspond to the bEndpointAddress member of the isochronous endpoint descriptor

3.20 USBROM.4

Introduction:

The LPC43x0 device family includes a USB full-speed interface that can operate in device mode and also, includes USB ROM based drivers. A Bulk-Only Protocol transaction begins with the host sending a CBW to the device and attempting to make the appropriate data transfer (In, Out or none). The device receives the CBW, checks and interprets it, attempts to satisfy the request of the host, and returns status via a CSW.

Problem:

When the device fails in the Command/Data/Status Flow, and the host does a bus reset / bus re-enumeration without issuing a Bulk-Only Mass Storage Reset, the USB ROM driver does not re-initialize the MSC variables. This causes the device to fail in the Command/Data/Status Flow after the bus reset / bus re-enumeration.

Work-around:

Implement the following software work-around to re-initialize the MSC variables in the USBD stack.

```
void *g pMscCtrl;
ErrorCode t mwMSC Reset workaround(USBD HANDLE T hUsb)
{
((USB MSC CTRL T *)g pMscCtrl)->CSW.dSignature = 0;
     ((USB MSC CTRL T *)g pMscCtrl)->BulkStage = 0;
     return LPC OK;
}
ErrorCode t mscDisk init(USBD HANDLE T hUsb, USB CORE DESCS T *pDesc,
     USBD API INIT PARAM T *pUsbParam)
     USBD MSC INIT PARAM T msc param;
     ErrorCode t ret = LPC OK;
     memset((void *) &msc param, 0, sizeof(USBD MSC INIT PARAM T));
     msc param.mem base = pUsbParam->mem base;
     msc param.mem size = pUsbParam->mem size;
     g pMscCtrl = (void *)msc param.mem base;
     ret = USBD API->msc->init(hUsb, &msc param);
     /* update memory variables */
     pUsbParam->mem base = msc param.mem base;
     pUsbParam->mem size = msc param.mem size;
```

```
return ret;
}

usb_param.USB_Reset_Event = mwMSC_Reset_workaround;
ret = USBD API->hw->Init(&g hUsb, &desc, &usb param);
```

3.21 SD/MMC.1

Introduction:

The LPC43x0 parts have the SD/MMC interface. After power up, the SD memory card is in the default speed mode, and by using the Switch Function command (CMD6), Version 1.10 and higher, the SD memory cards can be placed in high-speed mode. In response to the CMD6 command, the SD card returns a 512-bit block of data containing the available features and actual settings. The SDIO interface is setup for 4-bit data and therefore, the 512 bits are returned on the four data lines in 128 clocks followed by 16 clocks of CRC data.

Problem:

The CMD6 returned status block always gets a data CRC error although the status data is correct. The data CRC error prevents the switching of the SD memory card from the default mode to high-speed mode.

Work-around:

Capture the 64 bits of CRC data that follow the 512 bits of data allowing the CRC data to be calculated in software. The DMA buffer length and SD/MMC BYTCNT must be set to 72 (versus 64). The CRC data consists of four interleaved 16-bit words, one for each of the four serialized SD data bits. If all four of the calculated CRCs match the captured CRCs, the software can clear the data CRC error flag bit.

3.22 RESET.1

Introduction:

The LPC43x0 parts contain a Reset Generation Unit (RGU) that generates various resets; Core Reset (CORE_RST), Peripheral Reset (PERIPH_RST), Master Reset (MASTER RST), and M4 Reset (M4 RST).

Problem:

On the LPC43x0, MASTER RST and M4 RST are not functional.

Work-around:

There is no work-around. To reset the entire chip use the CORE RST instead of using MASTER_RST or M4_RST.

3.23 **RESET.2**

Introduction:

The LPC43x0 parts contain a Reset Generation Unit (RGU) that generates various resets; Core Reset (CORE_RST), Peripheral Reset (PERIPH_RST), Master Reset (MASTER_RST), and M4 Reset (M4_RST).

Problem:

On the LPC43x0, PERIPH_RST is not functional. CMSIS call NVIC_SystemReset() uses PERIPH_RST internally and is also non-functional.

Work-around:

There is no work-around. To reset the entire chip, use the CORE_RST instead of using CMSIS call NVIC_SystemReset() or PERIPH_RST.

3.24 RESET.3

Introduction:

The LPC43x0 devices are initialized after a reset. If a reset occurs via nRESET pin when the part is in deep-sleep or power-down mode, the initialization state of the device may be erroneous and some functionality of the device may be lost.

Problem:

When the part is in deep-sleep or power-down mode and if an external reset occurs via nRESET pin being activated, as the part comes out of reset, the reset state of some functional blocks may be incorrect. This may result in loss of functionality of the device. The actual functionality lost may vary from part to part depending on the erroneous reset state of the functional blocks. The possible affected blocks are: Ethernet, LCD controller, CAN0, CAN1, USB0, USB1, SGPIO, AES, Cortex-M0 coprocessor and Cortex-M0 subsystem (if present), 12-bit ADC, SRAM size at 0x1000 0000 may change to 32 kB, SRAM size at 0x1008 0000 may change to 40 kB, SRAM size at 0x2000 0000 may change to 16 kB, SRAM size at 0x2000 8000 may change to 0 kB, and SRAM size at 0x2000 C000 may change to 0 kB.

Work-around:

There are two possible work-arounds:

- 1. In the application software, before initializing peripherals, the code should assert a soft reset using the following steps:
 - a. Read the value in Power-down modes register (PD0_SLEEP0_MODE).
 - b. If the value in the PD0_SLEEP0_MODE0 register represents deep-sleep mode or power-down mode, then the user should check if a reset event occurred on the nRESET pin (bit '19' in the Event Status register).
 - c. If the reset event occurred, the software should set the PD0_SLEEP0_MODE register to deep power-down mode and assert a soft reset using the CORE_RST (bit '0' in the RESET_CTRL0 register).

2. To initialize the device correctly, assert a second external reset signal to the nRESET pin after 20 μ s from the first reset.

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3.25 RTC.1

Introduction:

The Real Time Clock (RTC) is a set of counters for maintaining a time base when system power is off, and optionally when it is on. The RTC block is designed to consume very little power, using an external 32.768 kHz crystal to generate a 1 Hz internal time reference. The RTC is powered by its own power supply pin, VBAT.

Problem:

On the LPC43x0 devices, when there is I/O switching activity on pins close to the RTCX1 pin, the RTC does not work reliably due to noise coupling into the 32.768 kHz oscillator circuit design. This results in additional (spurious) clock cycles for the counters and therefore in a time shift of the RTC.

On the LQFP144 package, I/O switching activity on pins P3_7 (pin number 123) and P3_8 (pin number 124) can cause noise coupling into the RTCX1 oscillator input pin (pin number 125).

Work-around:

- 1. The pins adjacent to RTCX1 can be avoided since the functions on these pins are multiplexed on other pins. However, if using the SPIFI interface, there are no alternative pins which have SPIFI functions. In that case, apply work-around 2.
- 2. If an on-chip 32.768 kHz oscillator is used, the RTCX1 pin will be sensitive to noise from the adjacent pins. Use an external 32.768 kHz clock source (from a host system or from an external oscillator) as an input to the RTCX1 pin to avoid noise coupling. See the application information section in the data sheet for more information on using an external clock.

4. AC/DC deviations detail

4.1 IBAT.1

Introduction:

The LPC43x0 contain a Real-Time Clock which measures the passage of time. The RTC has an ultra-low power design to support battery powered systems with a dedicated battery supply pin.

Problem:

On the LPC43x0, high current consumption of about 70 μ A may occur on the VBAT power supply pin.

Work-around:

VBAT current consumption can be lowered significantly by configuring the RTC_ALARM pin as "Inactive" by setting the ALARMCTRL 7:6 field in CREG0 to 0x3. These bits persist through power cycles and reset while VBAT is present.

For CREG0[13:12] reserved value 0x3 should be used; this value should be set once after a power on reset.

4.2 IBAT.2

Introduction:

The LPC43x0 contain a Real-Time Clock which measures the passage of time. The RTC has an ultra-low power design to support battery powered systems with a dedicated battery supply pin.

Problem:

On the LPC43x0, high current consumption of about 15 μ A may occur on the VBAT power supply pin despite applying the work-around in IBAT.1.

Work-around:

The problem is caused by a design error and there is currently no work-around.

4.3 PWR.1

Introduction:

The LPC43x0 contain several low-power modes. The PMC implements the control sequences to enable transitions between different power modes and controls the power state of each peripheral.

Problem:

A design error results in about 15 μ A higher current consumption during deep-sleep and power-down mode.

Work-around:

None.

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